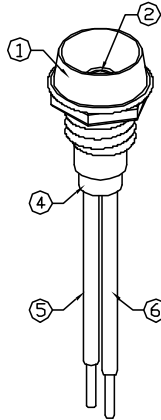
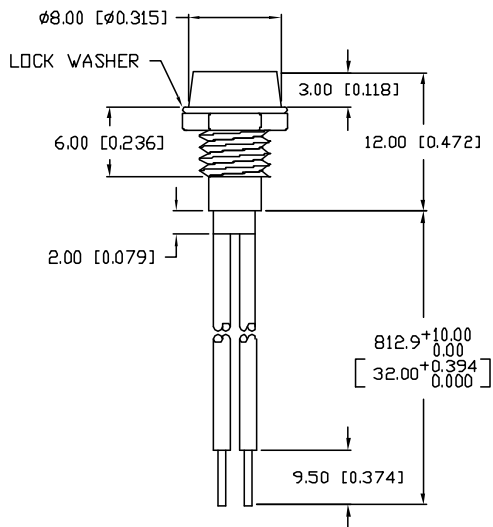


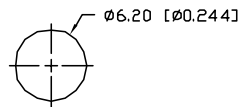
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SSI-LXR1612GD-815

REV.



PANEL CUTOUT



ELECTRO-OPTICAL CHARACTERISTICS $T_A=25^{\circ}\text{C}$ $I_f=20\text{mA}$

PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		565		nm	
FORWARD VOLTAGE		2.2	2.6	V _r	
REVERSE VOLTAGE	5.0			V _r	$I_f=100\mu\text{A}$
AXIAL INTENSITY		30		mcad	$I_f=20\text{mA}$
VIEWING ANGLE		60		2x theta	
EMITTED COLOR:	GREEN				
EPOXY LENS FINISH:	GREEN DIFFUSED				

LIMITS OF SAFE OPERATION AT 25°C

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	150	mA
STEADY CURRENT	25	mA
POWER DISSIPATION	105	mW
DERATE FROM 25°C	-1.6	mW/°C
OPERATING, STORAGE TEMP.	-40 TO +85	°C
SOLDERING TEMP.	+260	°C
2.0mm FROM BODY		3 SEC. MAX

* $t < 10\mu\text{s}$

NOTES:

- SSI-LXR1612, CHROME HOUSING.
- SSL-LX3054GD, GREEN LED. TRIM LEADS TO 5mm.
- SOLDER WIRE LEADS TO LEAD LEADS.
- SSH-LXH1612BSG, BUSHING. INSERT AND CRIMP.
- ANODE LEAD: LXP-WST26RDT0C, 26 AWG, STRANDED, RED INSULATION. CUT 817mm LONG, STRIP END 2mm & 9.5mm.
- CATHODE LEAD: LXP-WST26BLT0C, 26 AWG, STRANDED, BLACK INSULATION. CUT 817mm LONG, STRIP END 2mm & 9.5mm.

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*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), XI=±0.5 (±0.020), XIX=±0.25 (±0.010), XXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030). MIN= +DECIMAL PRECISION -0.00, MAX.= +0.00 -DECIMAL PRECISION

REV. PART NUMBER
SSI-LXR1612GD-815

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290 E. HELEN ROAD
PALATINE, IL 60067-6976
PHONE: +1.847.359.2790
US WEB: www.lumex.com
TW WEB: www.lumex.com.tw

T-3mm (T-1) 565nm GREEN LED PANEL INDICATOR,
GREEN DIFFUSED LENS, 32" WIRE LEADS.

RELIABILITY NOTE
OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.

DRAWN BY: JO
CHECKED BY:
APPROVED BY:
DATE: 11.11.04
PAGE: 1 OF 1
SCALE: N/A